



# UNITED STATES PATENT AND TRADEMARK OFFICE

UNITED STATES DEPARTMENT OF COMMERCE  
United States Patent and Trademark Office  
Address: COMMISSIONER FOR PATENTS  
P.O. Box 1450  
Alexandria, Virginia 22313-1450  
www.uspto.gov

APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/673,507	09/30/2003	Eric J. Strang	231751US6YA	1662
22850	7590	03/03/2010	EXAMINER	
OBLON, SPIVAK, MCCLELLAND MAIER & NEUSTADT, L.L.P. 1940 DUKE STREET ALEXANDRIA, VA 22314			SAXENA, AKASH	
			ART UNIT	PAPER NUMBER
			2128	
			NOTIFICATION DATE	DELIVERY MODE
			03/03/2010	ELECTRONIC

**Please find below and/or attached an Office communication concerning this application or proceeding.**

The time period for reply, if any, is set in the attached communication.

Notice of the Office communication was sent electronically on above-indicated "Notification Date" to the following e-mail address(es):

patentdocket@oblon.com  
oblonpat@oblon.com  
jgardner@oblon.com

1 RECORD OF ORAL HEARING  
2  
3 UNITED STATES PATENT AND TRADEMARK OFFICE  
4

5  
6 BEFORE THE BOARD OF PATENT APPEALS  
7 AND INTERFERENCES  
8

9  
10 *Ex parte* ERIC J. STRANG  
11

12  
13 Appeal 2009-007902  
14 Application 10/673,507  
15 Technology Center 2100  
16

17  
18 Oral Hearing Held: February 4, 2010  
19

20  
21 Before JAMES D. THOMAS, LANCE LEONARD BARRY, and  
22 STEPHEN C. SIU, *Administrative Patent Judges*.  
23

24  
25 APPEARANCES:  
26

27 ON BEHALF OF THE APPELLANT:  
28

29 RONALD A. RUDDER, ESQUIRE  
30 Oblon Spivak  
31 1940 Duke Street  
32 Alexandria, Virginia 22314  
33  
34  
35  
36  
37  
38

1       The above-entitled matter came on for hearing on Thursday, February  
2   4, 2010, commencing at 9:33 a.m., at the U.S. Patent and Trademark Office,  
3   600 Dulany Street, Alexandria, Virginia, before Paula Lowery, Notary  
4   Public.

5   THE CLERK: Good morning. Calendar Number 24, Mr. Rudder.

6   MR. RUDDER: May it please the Board, today I plan to talk about the  
7   points we emphasized in the Reply Brief. In particular, I'd like to point to  
8   what I consider to be disagreements between the Examiner and Appellant in  
9   terms of their reading of Sonderman.

10   I'd also like to point out that while we believe the features relied on in Tan,  
11   et al. and in Jain are really not appropriately applied to the claims of the  
12   present application.

13   Then I'd like to spend some time, if time permits, to basically talk about  
14   some secondary considerations that were pointed out in the Reply Brief.

15   If you'll look briefly at Claim 1, Claim 1 has a number of features I'd like to  
16   highlight for just a moment. The first element of Claim 1 talks about  
17   inputting process data related to the actual process being performed.

18   The second element talks about inputting of first principles, physical  
19   modeling, including a set of computer encoded differential equations.

20   I'd like to stop for a moment right there and then, with reference to  
21   Sonderman, talk for a minute about the difficulty of, basically, solving the  
22   first principles modeled.

23   Basically, the first principles modeled, as you can tell from the spec, is  
24   related to solving equations such as Maxwell equations, the Navier-Stokes  
25   theorem tied to equations, and these are typically differential equations that  
26   take a great deal of computing power. Indeed, the only reference that really

1 seems to come close to addressing a capability of doing that is the Jain, et al.  
2 reference.

3 If we look specifically at Sonderman, the Appellants contend that, basically,  
4 Sonderman is a simulation-type process; but the simulation process seems to  
5 be run in a feedback, or perhaps at most a feed forward-type mechanism.

6 In Figure 1 of Sonderman, you can see, as pointed out in the Reply Brief on  
7 pages 5 and 6, that a metrology tool is used there to provide metrology data  
8 which feeds back into the upper left-hand side into a simulation  
9 environment.

10 That simulation environment in Column 8 of Sonderman and Column 5 of  
11 Sonderman, for example, produces device physics models or manufacturing  
12 recipes. Those recipes are then used to control the processing that goes in  
13 processing tool A.

14 One major point of disagreement in reading the reference involves Column  
15 9, lines 46-51 of Sonderman, and the Reply Brief quoted that, and I'll just  
16 read it briefly to you.

17 It says: "The system then optimizes simulation described above to find more  
18 optimal process targets for each silicon wafer SFI to be processed. These  
19 target values are then used to generate new control inputs on Line 805 to  
20 control a substantive process with silicon wafer SFI."

21 We believe the language here and the whole of Sonderman indicates that  
22 these subsequent processes are for subsequent wafers, else this would not be  
23 consistent with the feedback process as described.

24 It also would not be consistent with the diagram of Figure 4, which shows in  
25 a nutshell that Sonderman finds a process to be modeled. He basically runs  
26 the model to obtain a simulation result. He's not running a first principle

1 simulation itself.

2 He then interfaces the simulation results or processor, and then the processor  
3 runs a control under the preexisting simulation result, or what Sonderman  
4 referred to as a manufacturing recipe.

5 The Examiner in his particular rebuttal has read additional terms into  
6 Sonderman where he believes that, basically, this means that a subsequent  
7 process of a silicon wafer SFI refers to a process occurring on the same  
8 wafer at a subsequent time.

9 Turning now to Tan, et al, Tan, et al. was asserted for teaching of first  
10 principal simulation results being produced in a time frame shorter than the  
11 actual time frame being performed. It was also cited for a model-based real  
12 time process using in situ inputs, but that limitation is in some of the  
13 dependent claims.

14 So we pointed out in the Reply Brief on page 17 that here, once again, like  
15 Sonderman Tan is very explicit in saying that his APC, his process control  
16 system, receives feed forward and feedback data.

17 To the Appellant that means that he's not controlling the process that's  
18 ongoing with the data being received from the process that is ongoing.

19 Rather he, like Sonderman, is making some measurement of what has  
20 happened; and using feedback control to control a subsequent wafer, or in  
21 this case when Tan is talking about feed forward control, he's measuring  
22 some property before the wafer, and it's a processing tool. Based on that  
23 property, such as the thickness of photo resist, he's then setting the recipe to  
24 accommodate those measurements ahead of time.

25 JUDGE SIU: Could you comment on Tan Column 2 where he says an

1 advanced process control framework provides model-based real time  
2 processing parameters during the process run. It's Column 2, about line 10  
3 or so.

4 MR. RUDDER: Yes, the first thing I remember about that particular  
5 comment is he actually points out in the earlier column that these are  
6 unresolved issues. As I recall, that's the word he used. Then, supposedly,  
7 his invention would address all these.

8 I didn't actually see in Tan, in the body of the invention, where he actually  
9 described a real time control. He mostly described run-to-run control from  
10 wafer to wafer. But regardless, the important point there is if it's model  
11 based, it means that in Appellant's view a model has been developed,  
12 probably from some first-principle simulation.

13 For example, you all are probably aware of Ohm's Law, which describes  
14 how current flows down a wire. You can basically say the voltage is equal  
15 to the current times the resistance. That's a model of what happens in a well-  
16 defined geometry when Maxwell's equations are applied.

17 You can take that model and use it quite frequently and often because it's a  
18 reduction from what you might consider is a derivation from Maxwell's  
19 equations.

20 So even here if we accept that Tan did do real time processing, he taught that  
21 in the body of his specification of his invention, it still seems he's once again  
22 using models to control, much like Sonderman talked about using a device  
23 physics model to control.

24 So the issue here from a technical challenge point of view -- the reason the  
25 Appellant believes other people have not done this is it's time intensive.

26 Most time the calculations require so much time that you, essentially, have

1 to go to a statistical situation or a recipe situation where your process  
2 controller can use that statistical information or the recipe information to  
3 manage the process control.

4 JUDGE SIU: Sonderman has the simulation environment that makes  
5 process data that goes to the manufacturing environment. The  
6 manufacturing environment is the actual process, I'm assuming, in your  
7 claim.

8 So the parameters are made in conjunction with a simulation environment,  
9 isn't that right? Then it goes into the manufacturing environment to actually  
10 apply those parameters.

11 Tan discloses process-controlled parameters and those process-controlled  
12 parameters are similar to those process parameters that are going into the  
13 manufacturing environment in Sonderman. So if we look at it that way, I'm  
14 having a hard time seeing a difference between the claimed feature of  
15 performing a simulation during an actual process and generating process-  
16 control parameters in Tan, which is a simulation similar to that in  
17 Sonderman, to control the manufacturing process, such as disclosed in  
18 Sonderman, during the process run, as disclosed in Tan. Could you point  
19 out what you believe to be the difference between generating the process-  
20 control parameters in Tan, which sounds like a simulation as disclosed in  
21 Sonderman, during the actual process and the claimed feature of performing  
22 a simulation during the performance of the actual process?

23 MR. RUDDER: I'll try to answer your question. I think I understand it.  
24 I think in reality my belief of what happens is in Sonderman and in Tan you,  
25 basically, have a model.

1 In Sonderman the model comes from a simulation result. It doesn't say it's a  
2 first principle simulation, but nevertheless it comes from simulation results.  
3 So they simulate the process, and they make a theoretical silicon wafer.  
4 Then they derive a manufacturing control recipe. That recipe is like a  
5 model.

6 So when the process control tries to change the pressure in a given process,  
7 it looks to see what the manufacturing recipe says it should do. Almost like  
8 a look-up table. So it's taken all the up front calculations and all the  
9 knowledge derived from the fundamental physics, and it's distilled it down  
10 into a model.

11 Now, the model is what's being used real time to control the process. It  
12 doesn't need to go back and do a first run simulation. It doesn't need to go  
13 back to the fundamental Maxwell equations. It's going to use the simplified  
14 model,  $B=IR$  to control what goes on.

15 Because it's such a simple algorithm, it can calculate that, or it can use look-  
16 up tables, and it can quickly find how to control the process real time; but it's  
17 not going back and redoing the simulation every time when it needs to make  
18 a decision about what to do with a wafer inside the processing --

19 JUDGE THOMAS: Counsel, what does any of this have to do with the  
20 subject matter of Claim 1 to distinguish over what's there?

21 MR. RUDDER: The subject matter in Claim 1, Step 3 says that you perform  
22 the first principle simulation for the actual process being performed during  
23 the performance of the actual process.

24 So here I think the distinction is the art now used does perhaps some type of  
25 simulation. We just don't think it's first principles. But it does it off line or  
26 beforehand.



1 JUDGE THOMAS: What does the claim recite as to what the first principle  
2 is?

3 MR. RUDDER: It says in Step 2 that the first principle physical model  
4 describes at least one of the basic physical or chemical attributes of a semi-  
5 conductor processing tool, and it also describes in Step 2 that it includes this  
6 computer-encoded differential equations.

7 JUDGE THOMAS: Those are the only things that you have recited in the  
8 claim to define that language, right?

9 MR. RUDDER: Yes, it is. Plus the fact that first principles is itself a well-  
10 known term in the art. In fact, if you look at Jain for evidence of, basically,  
11 trying to use a first principle type of calculation.

12 JUDGE THOMAS: Okay. Go ahead.

13 MR. RUDDER: In fact, let's then move forward if we can to look at Jain for  
14 just a minute. Jain talks about -- the Examiner applies it for the teaching of a  
15 computer-encoded differential equation.

16 Here they have what they have as a mathematical physical engine. The part  
17 that we pointed out to the Examiner is that all this scientific paper seems to  
18 do is propose or make conjecture about the type of computer that would be  
19 needed, or the type of computer processing that would be needed to basically  
20 achieve such a brute force calculation.

21 You can see there that they, for example, highlight in the Reply Brief on  
22 pages 10 and 11 -- they envision using courtyards of processors. They talk  
23 about using thousands of processors.

24 They talk about the construction of a hypothetical, futuristic type of wafer-  
25 stacking scheme that can interconnect these wafers to where perhaps they  
26 can have the super computing skills they need.

1 We do not believe that a person in a semi-conductor manufacturing art --  
2 once again the preamble of Claim 1 says the processes are formed by a semi-  
3 conductor processing tool -- that that person is going to, basically, even  
4 consider applying a hypothetical, unproven, untested system such as Jain  
5 into this particular affair.

6 So we think that Jain essentially backs up the Applicant's position which he  
7 stated in the specification that was discussed in the Reply Brief on pages 11  
8 and 12. There the inventors basically pointed out that people recognize the  
9 difficulties and the large number of simulations that have been done, and  
10 historically these simulations were confined to process-development tools or  
11 design tools when time was not an issue.

12 You could take three days for a calculation to run to solve a tool geometry  
13 that you thought was an optimum, but people have struggled -- there was  
14 failures of inertia they talk about, and people of ordinary skill in the art, the  
15 bottom line -- they typically felt there was inefficient use, and basically the  
16 extensive computation resources have been a major impediment to  
17 implementing the invention.

18 This seems to be also backed up by a couple of references that we brought to  
19 the Examiner's attention. I think his position is that he can apply at least  
20 Key, so it's not particularly relevant, but we bring it as a secondary  
21 consideration.

22 Here Key, which we talked about in our Reply Brief, pages 13 and 14, they  
23 are faced with a similar dilemma --

24 JUDGE THOMAS: Counselor, did you bring this secondary consideration  
25 argument and evidence before the Examiner in the Brief?

26 MR. RUDDER: I think we actually introduced this back during prosecution.

1 JUDGE THOMAS: Did you make use of it in the Principal Brief?

2 MR. RUDDER: In the Principal Brief? Yes, I'm fairly sure we did. Do you  
3 want the citation to the page?

4 JUDGE THOMAS: Please.

5 MR. RUDDER: Yes, page 22 and it probably continues forward to 23, it  
6 looks like. Certainly at page 22, and it says: "As specifically part of our  
7 Key, et al. reference is evidence of the technological difficulties involved in  
8 producing a first principle model simulation," et cetera, et cetera.

9 So that argument was advanced in the Appeal Brief.

10 So, finally, I think we're going to point out that Chen also seems very  
11 irrelevant because, basically, they also were doing a simulation-type of  
12 calculation. Here they also point out, and this is the Reply Brief on pages 14  
13 through 15 that the tools for simulation had generally been developed for  
14 research and development purposes and do not adequately address various  
15 difficulties that arise in the manufacturing environment.

16 Chen takes a slightly different approach. He uses a statistical simulation  
17 type of affair where, basically, he analyzes things such as variations, mean  
18 deviations, and from a long-type of process, empirical-based process, he  
19 comes forward with a process-control situation.

20 JUDGE THOMAS: Counsel, you've just about expired your time.

21 MR. RUDDER: I'm on my last page. Are there any further questions?

22 JUDGE THOMAS: I don't believe so.

23 MR. RUDDER: Thank you very much.

24 Whereupon, at 9:52 a.m. the proceedings were concluded.

25